





SPECIFICATION FOR 2.5V LVPECL SMT TCXO MtronPTI P/N M6301S018

Electrical Specifications:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Frequency of Operation	Fo		125.000000		MHz	
Frequency Tolerance		-1.0		+1.0	ppm	@ +25°C
		F	requency Sta	ability		
vs. Temperature	ΔF/F			4.6	ppm	(Max-Min)/2
vs. Aging		-3		+3	ppm	1 st year
		-1		+1	ppm	Per year thereafter.
			RF Outpu	ıt		
Output Type		Cor	nplementary LV	PECL		
Output Type			Compatible			
Output Load		50 Ω to (V _{CC} – 2)			V	
Logic "1" Level Output	V _{OH}	V _{cc} – 1.025			V	
Logic "0" Level Output	Vol			V _{cc} – 1.62	V	
Symmetry (Duty Cycle)	T _{DC}	45		55	%	Ref. at 50% of waveform
Rise/Fall Time	T _R /T _F			0.35	nS	From 20% to 80% Vcc
	S	upply Vo	Itage & Powe	r Consump	tion	
Operating Voltage	Vcc	2.375	2.5	2.625	V	
Operating Current	Icc			120	mA	

Environmental Conditions:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Operating Temperature	T _A	-55		+125	°C	
Storage Temperature	Ts	-55		+125	°C	
Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)					
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)					
Thermal Shock	Per MIL-STD-883, Method 1011, Condition A					
Thermal Cycle	Per MIL-STD-883, Method 1010, Condition B					
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 ⁻⁸ atm cc/s of helium)					
Solderability	Per EIAJ-STD-002					
Max. Soldering Conditions	See Figure 1.					
Package Type	6-pad 5.0 X 7.0 X 1.9 mm leadless ceramic. RoHS compliant.					

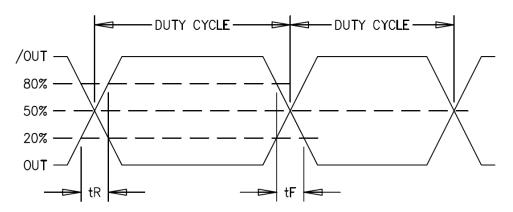




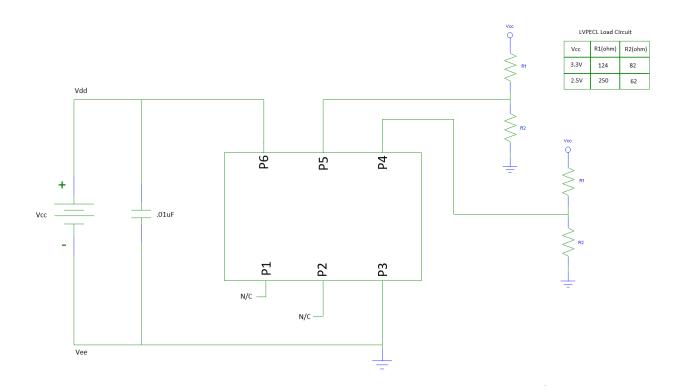


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Output Waveform:



Typical Test Circuit & Load Circuit Diagrams:









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Soldering Conditions:

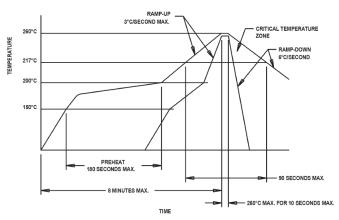
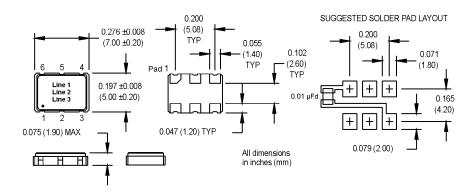


Figure 1

Mechanical, Marking, and Pin Out Information:



Datasheet Revision Table:

Date	Rev.	Author	Details of Revision			
01/18/19	0	MM	Original release			